

Raffar Technology Corp.



Built-in Shift Register 8-channel N-MOS with Anti-ghosting Control Function

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Description

RT5929 is an 8-channel N-MOS for common cathode high refresh rate LED display application. Built-in the 8-bit shift register, RT5929 makes the data transfer by serial connection without decoding component on board to simplify the PCB layout.

By giving a very simple control model to let controller determined the turn-on, pre-charge, and row blank timing, the RT5929 can effectively to eliminate the LED ghosting phenomena, to remove LED cascading/cross bright line caused by a LED short or LED open, and also to avoid the over reverse voltage to damage LEDs in order to raise the display performance.

Features

- 8-channel NMOS for common cathode LED display application
- Built-in anti-ghosting function for dynamic display
- Built-in circuit to eliminate the LED cascading and cross bright line caused by LED defected (Timing adjustment with controller)
- Serial Data connection transfer for easy and simplified PCB layout
- Wipe off 138 decoder
- Low standby current(IDD_off):43.6uA (typ.)
- Extra low RDS(on)

 $R_{DS(ON)}$, V_{gs} @5.0V, I_{ds} @1.0A 100m Ω (typ.)

Application

Indoor and outdoor common-cathode LED display

Order Information

No.	Part No.	Package	
1	RT5929SP	SOP16-150 mil-1.27 mm	
2	RT5929QN	QFN16-4mm*4mm	

Pin Assignment







Recommend Application Circuit

To have the best performance of fine pitch dynamic LED display, RT5929 provides the pre-charge circuit to eliminate the ghosting from LED row. However, there is also a slight LED ghosting from the LED column which needs to use a constant current LED driver IC (e.g. RT5966) with discharging circuit to achieve the non-ghosting display performance.

By controlling the output turn-off time and row blank timing, the RT5988 can effectively avoid the over reverse voltage to damage LEDs and eliminate LED cascading and cross bright line caused by a LED short and open.

RT5929 is an integrated 8 outputs power MOS. To avoid the overheating issue, the IC power dissipation and the thermal design has to be put in consideration of design.





Package Outline

SOP16 Dimension (150mil, 1.27mm)







Consolt of	Millimeter (mm)		
Symbol	Min.	Max.	
А	1.30	1.75	
A1	0.10	0.25	
b	0.30	0.55	
С	0.15	0.35	
D	9.70	10.3	
Е	3.75 4.15		
Н	5.80	6.20	
e	1.27 (BSC)		
L	0.40	1.25	
θ°	0	8	

Confidential Information



QFN16 4x4mm Dimension

TOP VIEW



BOTTOM VIEW





	Millimeters (mm)			
Symbol	Min.	Nom.	Max.	
А	0.70	0.75	0.80	
A1	0.00		0.05	
A3	0.203 Ref.			
b	0.24	0.29	0.34	
D	3.90	4.00	4.10	
D1	2.40	2.50	2.60	
Е	3.90	4.00	4.10	
E1	2.40	2.50	2.60	
е	0.65 BSC			
L	0.40	0.48	0.55	



Note

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